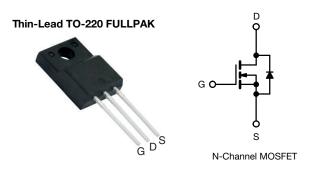
SiHA180N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V_{DS} (V) at T_J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.155				
Q _g max. (nC)	33				
Q _{gs} (nC)	7				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free and halogen-free	SiHA180N60E-GE3				

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current (T _J = 150 °C) $^{\circ}$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1-	9	А	
	VGS at TO V	T _C = 100 °C	Ι _D	6		
Pulsed drain current ^a			I _{DM}	44	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	111	mJ	
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	in-source voltage slope $T_J = 125 \text{ °C}$		al / alt	100	1//20	
Reverse diode dv/dt d			dv/dt	22	V/ns	
Soldering recommendations (peak temperature	e) ^c	For 10 s		260	°C	
Mounting torque, M3 screw				0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.8 A
- c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

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COMPLIANT HALOGEN



Vishay Siliconix

THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65		°C (M				
Maximum junction-to-case (drain)	R _{thJC}	- 3.8			- °C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, t	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C	, I _D = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}	Ň	V _{GS} = ± 30	V	-	-	± 1	μA
7		V _{DS} =	: 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	', V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١	₀ = 9.5 A	-	0.155	0.180	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 20 V, I _D =	= 9.5 A	-	5.3	-	S
Dynamic	•	•						1
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1085	-	pF	
Output capacitance	C _{oss}			-	56	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	41	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	251	-		
Total gate charge	Qg				-	22	33	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 9.5 A, V _{DS} = 480 V		-	7	-	nC	
Gate-drain charge	Q _{gd}				-	11	-	
Turn-on delay time	t _{d(on)}		•		-	14	28	
Rise time	t _r	V _{DD} =	V _{DD} = 480 V, I _D = 9.5 A,		-	49	98	1
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	22	44	ns	
Fall time	t _f			-	23	46		
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characterist		•			•	•		
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19		
Pulsed diode forward current	I _{SM}			-	-	44	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 9.5 A	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	282	564	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 9.5 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	3.6	7.2	μC	
Reverse recovery current	I _{RRM}			-	24	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



SiHA180N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

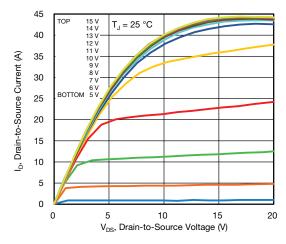


Fig. 1 - Typical Output Characteristics

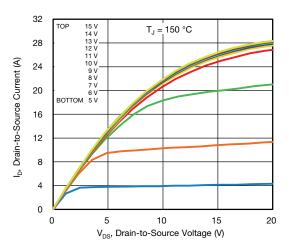


Fig. 2 - Typical Output Characteristics

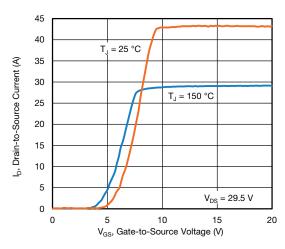


Fig. 3 - Typical Transfer Characteristics

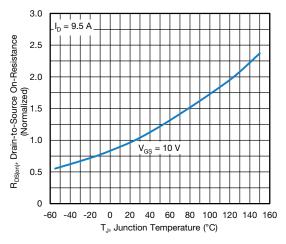


Fig. 4 - Normalized On-Resistance vs. Temperature

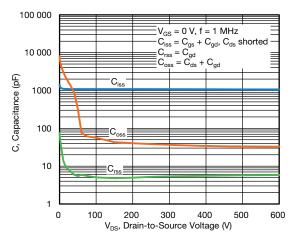


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

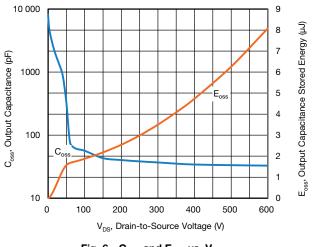


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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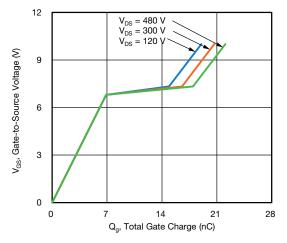


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

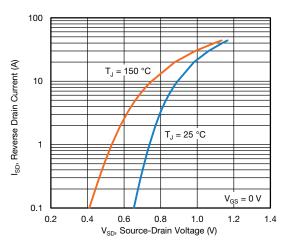


Fig. 8 - Typical Source-Drain Diode Forward Voltage

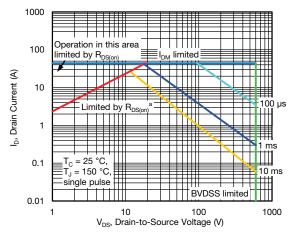


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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V_{DS}, Drain-to-Source Breakdown Voltage (V) 700 675 I_D = 250 μA 650 625 600 575 0 20 40 60 80 100 120 140 160 -40 -20 -60 T_J, Junction Temperature (°C) Fig. 11 - Temperature vs. Drain-to-Source Voltage

10

8

6

4

2

0

775

750 725

25

50

75

T_C - Case Temperature (°C)

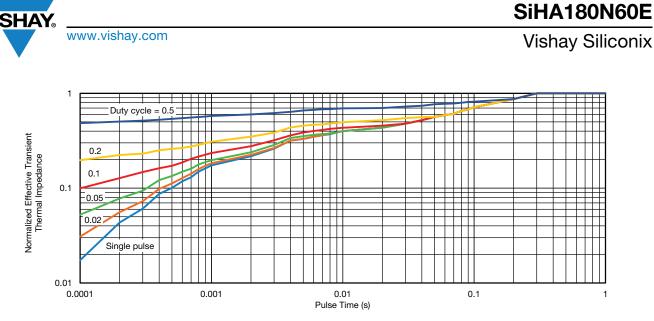
Fig. 10 - Maximum Drain Current vs. Case Temperature

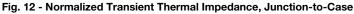
100

125

150

I_D - Drain Current (A)





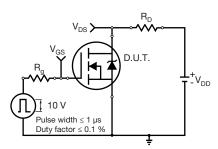


Fig. 13 - Switching Time Test Circuit

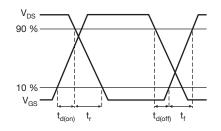


Fig. 14 - Switching Time Waveforms

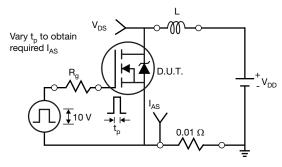


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

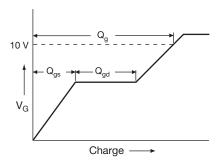


Fig. 17 - Basic Gate Charge Waveform

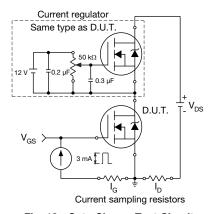
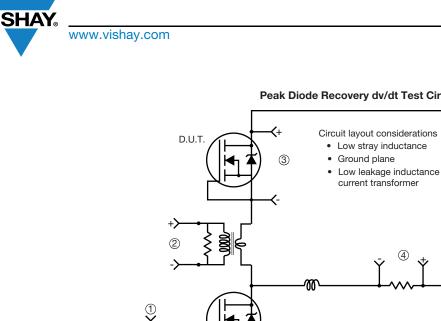


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

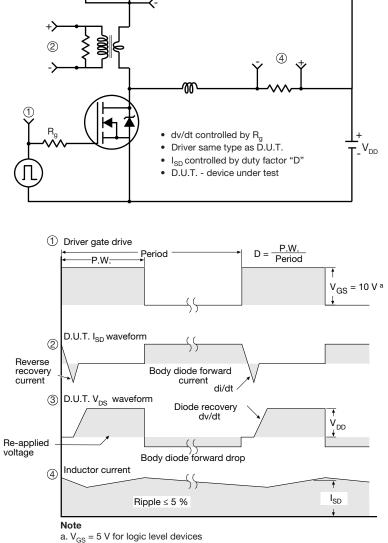


Fig. 19 - For N-Channel

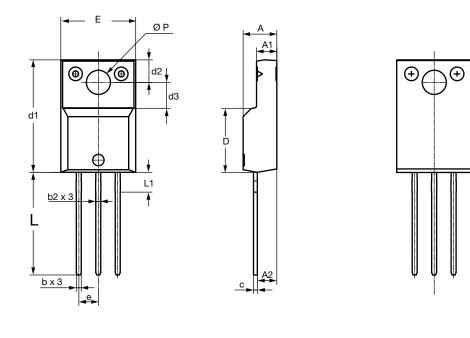
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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